

30V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8 (Type UX)

Product Summary

| BV _{DSS} | R _{DS(ON)} Max | I _D Max T _C = +25°C | | |
|-------------------|-----------------------------|--|--|--|
| 30V | $7m\Omega$ @ $V_{GS} = 10V$ | 60A | | |
| 30 V | $11m\Omega @ V_{GS} = 4.5V$ | 6UA | | |

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}), yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

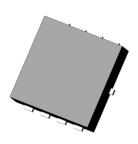
- Power Management Functions
- Analog Switch

Features

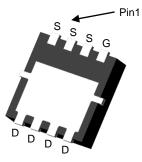
- Low R_{DS(ON)} Ensures On-State Losses are Minimized
- 100% Unclamped Inductive Switching (Test in Production) Ensures More Reliable and Robust End Application
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies just 33% of the Board Area Occupied by SO-8 Enabling Smaller End Product
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

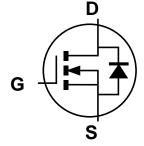
- Case: PowerDI[®]3333-8 (Type UX)
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 [®]
- Weight: 0.03 grams (Approximate)







Bottom View



Equivalent Circuit

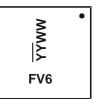
Ordering Information (Note 5)

| h- | | |
|----------------|-------------------------|-------------------|
| Part Number | Case | Packaging |
| DMT3006LFVQ-7 | PowerDI3333-8 (Type UX) | 2,000/Tape & Reel |
| DMT3006LFVQ-13 | PowerDI3333-8 (Type UX) | 3,000/Tape & Reel |

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



FV6 = Product Type Marking Code

YYWW = Date Code Marking

YY = Last Two Digits of Year (ex: 18 = 2018)

WW = Week Code (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated.



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | | |
|--|-----------------|----------------------------------|-----------------|----------|----|
| Drain-Source Voltage | | | V_{DSS} | 30 | V |
| Gate-Source Voltage | | | V_{GSS} | ±20 | V |
| Continuous Drain Current, V _{GS} = 10V (Note 8) | Steady State | $T_C = +25$ °C $T_C = +70$ °C | I _D | 60 45 | А |
| Maximum Body Diode Forward Current (Note 8) | Is | 2 | Α | | |
| Pulsed Drain Current (380µs Pulse, Duty Cycle = 1% | I _{DM} | 90 | Α | | |
| Pulsed Drain Body Diode Forward Current (380µs Pulse, Duty Cycle = 1%) | | | I _{SM} | 90 | Α |
| Avalanche Current (L = 0.1mH) (Note 9) | | | I _{AS} | 24 | Α |
| Avalanche Energy (L = 0.1mH) (Note 9) | | | E _{AS} | 29 | mJ |

Thermal Characteristics ($@T_A = +25^{\circ}C$, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit |
|--|--------------|-----------------|-------------|------|
| Total Power Dissipation (Note 6) | | P_{D} | 1.0 | W |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State | $R_{	heta JA}$ | 130 | °C/W |
| Total Power Dissipation (Note 7) | | P_{D} | 2.0 | W |
| Thermal Resistance, Junction to Ambient (Note 7) | Steady State | $R_{	heta JA}$ | 63 | °C/W |
| Thermal Resistance, Junction to Case (Note 8) | | $R_{\theta JC}$ | 2.9 | C/VV |
| Operating and Storage Temperature Range | | $T_{J,}T_{STG}$ | -55 to +150 | °C |

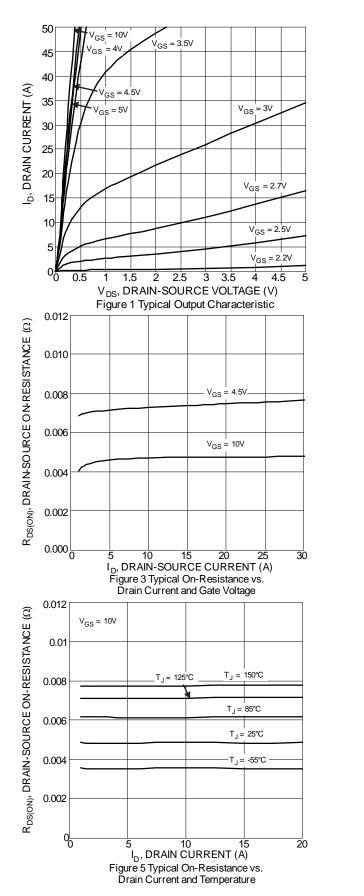
Electrical Characteristics (@ $T_A = +25$ °C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|--|---------------------|-----|-------|------|-------|--|--|
| OFF CHARACTERISTICS (Note 10) | | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | 30 | _ | _ | V | $V_{GS} = 0V, I_D = 250\mu A$ | |
| Zero Gate Voltage Drain Current T _J = +25°C | I _{DSS} | _ | _ | 1 | μΑ | $V_{DS} = 24V$, $V_{GS} = 0V$ | |
| Gate-Source Leakage | I _{GSS} | _ | _ | ±100 | nA | $V_{GS} = +20V, V_{DS} = 0V$ $V_{GS} = -16V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 10) | | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | 1.0 | | 3.0 | ٧ | $V_{DS} = V_{GS}$, $I_D = 250\mu A$ | |
| Static Drain-Source On-Resistance | Dagger | | 5.6 | 7 | mΩ | $V_{GS} = 10V, I_D = 9.0A$ | |
| Static Dialii-Source Off-Resistance | R _{DS(ON)} | | 8.0 | 11 | 11122 | $V_{GS} = 4.5V, I_D = 8.5A$ | |
| Diode Forward Voltage | V_{SD} | _ | 0.70 | 1.2 | ٧ | $V_{GS} = 0V, I_{S} = 1A$ | |
| DYNAMIC CHARACTERISTICS (Note 11) | | | | | | | |
| Input Capacitance | C _{iss} | _ | 1,155 | _ | | V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz | |
| Output Capacitance | Coss | _ | 456 | | pF | | |
| Reverse Transfer Capacitance | C _{rss} | _ | 72 | _ | | | |
| Gate Resistance | R_g | _ | 1.6 | _ | Ω | $V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$ | |
| Total Gate Charge (V _{GS} = 4.5V) | Q_g | _ | 8.4 | _ | | | |
| Total Gate Charge (V _{GS} = 10V) | Q_g | _ | 16.7 | _ | nC | V _{DD} = 15V. I _D = 9A | |
| Gate-Source Charge | Q_{gs} | _ | 2.2 | | IIC | V _{DD} = 15V, I _D = 9A | |
| Gate-Drain Charge | Q_{gd} | _ | 3.5 | _ | | | |
| Turn-On Delay Time | t _{D(ON)} | _ | 3.5 | _ | | | |
| Turn-On Rise Time | t _R | _ | 5.5 | _ | | $V_{DD} = 15V$, $V_{GS} = 10V$, $R_G = 3\Omega$, $I_D = 9A$ | |
| Turn-Off Delay Time | t _{D(OFF)} | _ | 13.5 | _ | ns | | |
| Turn-Off Fall Time | t _F | _ | 4.6 | _ | | | |
| Reverse Recovery Time | t _{RR} | _ | 19.3 | _ | ns | 1 4 5 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 | |
| Reverse Recovery Charge | Q _{RR} | _ | 8.6 | _ | nC | $I_F = 1.5A$, di/dt = 100A/ μ s | |

Notes:

- 6. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- 7. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 8. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 9. IAS and EAS ratings are based on low frequency and duty cycles to keep $T_J = +25$ °C.
- 10. Short duration pulse test used to minimize self-heating effect.
- 11. Guaranteed by design. Not subject to product testing.





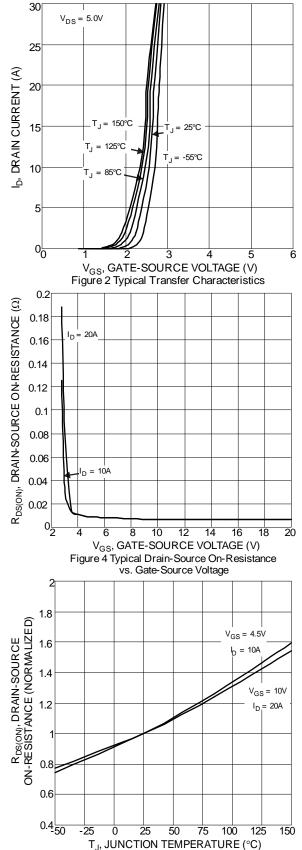
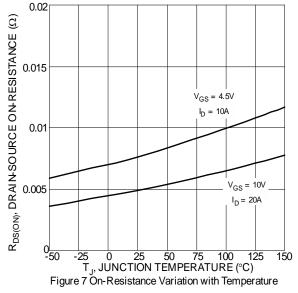
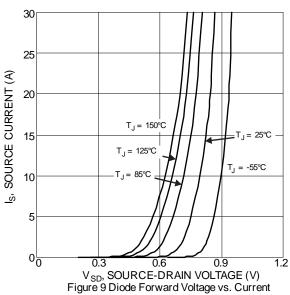
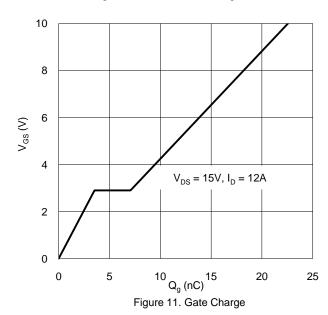


Figure 6 On-Resistance Variation with Temperature









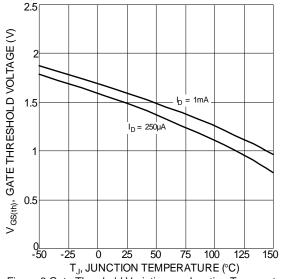
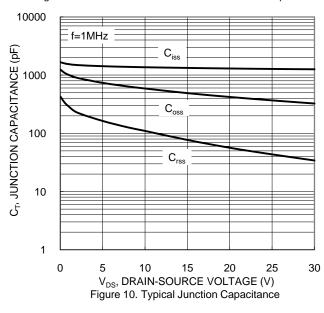
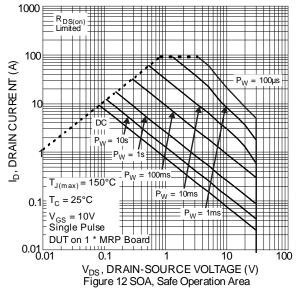
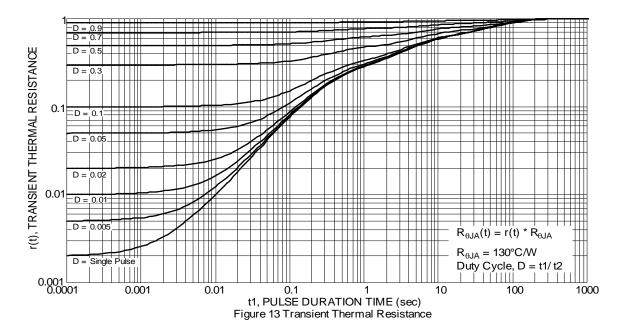


Figure 8 Gate Threshold Variation vs. Junction Temperature







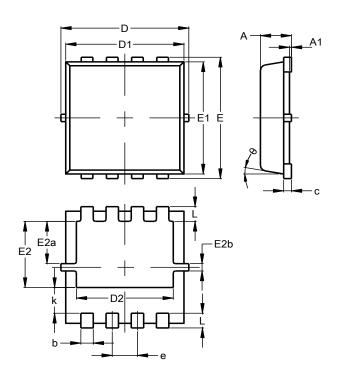




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (Type UX)

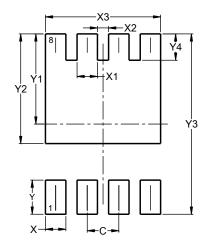


| PowerDI3333-8 | | | | | | |
|----------------------|----------|------|------|--|--|--|
| (Type UX) | | | | | | |
| Dim | Min | Max | Тур | | | |
| Α | 0.75 | 0.85 | 0.80 | | | |
| A1 | 0.00 | 0.05 | | | | |
| b | 0.25 | 0.40 | 0.32 | | | |
| С | 0.10 | 0.25 | 0.15 | | | |
| D | 3.20 | 3.40 | 3.30 | | | |
| D1 | 2.95 | 3.15 | 3.05 | | | |
| D2 | 2.30 | 2.70 | 2.50 | | | |
| Е | 3.20 | 3.40 | 3.30 | | | |
| E1 | 2.95 | 3.15 | 3.05 | | | |
| E2 | 1.60 | 2.00 | 1.80 | | | |
| E2a | 0.95 | 1.35 | 1.15 | | | |
| E2b | 0.10 | 0.30 | 0.20 | | | |
| е | 0.65 BSC | | | | | |
| k | 0.50 | 0.90 | 0.70 | | | |
| L | 0.30 | 0.50 | 0.40 | | | |
| θ | 0° | 12° | 10° | | | |
| All Dimensions in mm | | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (Type UX)



| Dimensions | Value (in mm) | | | |
|------------|---------------|--|--|--|
| С | 0.650 | | | |
| Х | 0.420 | | | |
| X1 | 0.420 | | | |
| X2 | 0.230 | | | |
| Х3 | 2.370 | | | |
| Υ | 0.700 | | | |
| Y1 | 1.850 | | | |
| Y2 | 2.250 | | | |
| Y3 | 3.700 | | | |
| Y4 | 0.540 | | | |



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